

I hereby certify that this correspondence is being deposited with the United States Postal Service with postage prepaid as first class mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231, on the date indicated below.

*Lisa M. Pinnella*

Signature of Person Mailing Paper or Fee

6-27-02  
Date of Signature

**COPY OF PAPERS  
ORIGINALLY FILED**

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In the Application of )  
)

RICHARD R. HENGST )  
)

on APPARATUS AND METHOD OF )  
MAKING A SLIP FREE WAFER BOAT )  
)

Serial No.: 09/884,720 )  
)

Filed on: June 19, 2001 )  
)

Group Art Unit: 2825  
Exmr.: Unknown

(Our Docket No. 6096-01)

RECEIVED  
JUL 17 2002  
TECHNOLOGY CENTER 2800

ASSISTANT COMMISSIONER FOR PATENTS  
Washington, D.C. 20231

LETTER TO THE OFFICIAL DRAFTSMAN

Dear Sirs:

Applicant hereby submits five (5) sheets (Figs. 1-5) of formal drawings to replace the informal drawings forming part of the application as on file.

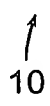
Respectfully submitted,

By

*Stephen P. Scuderi*

Stephen P. Scuderi  
Registration No. 42,136  
Attorney for Applicants

MCCORMICK, PAULDING & HUBER LLP  
CityPlace II, 185 Asylum Street  
Hartford, CT 06103-4102  
Tel: (860) 549-5290



2

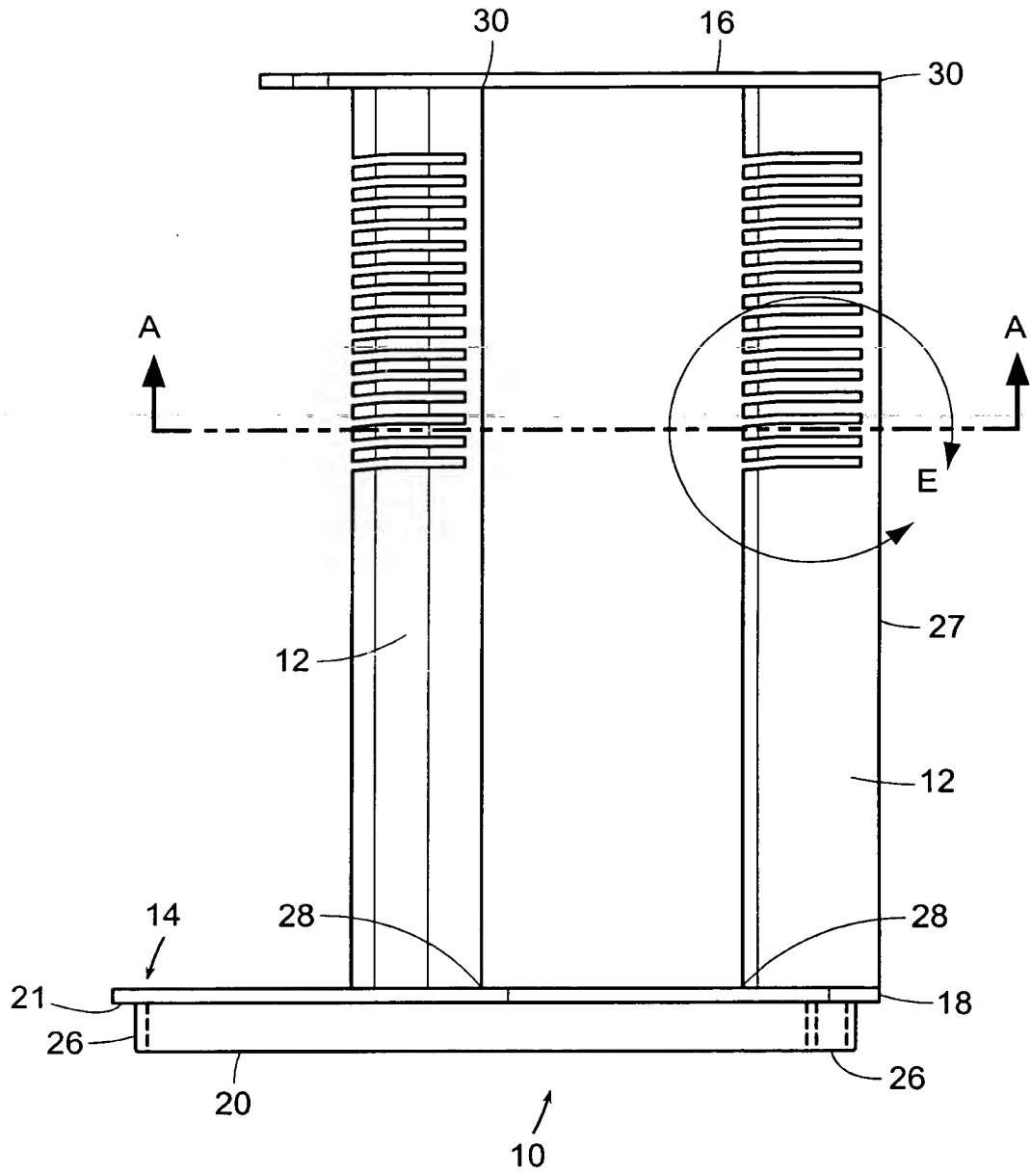


FIG. 2

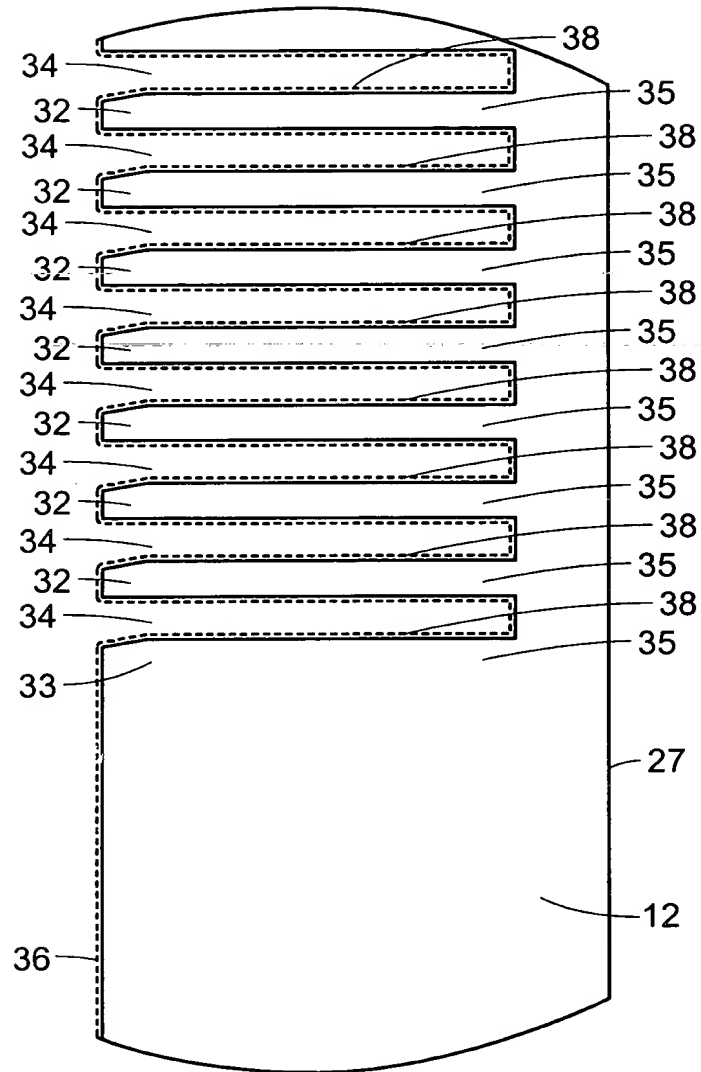


FIG. 3

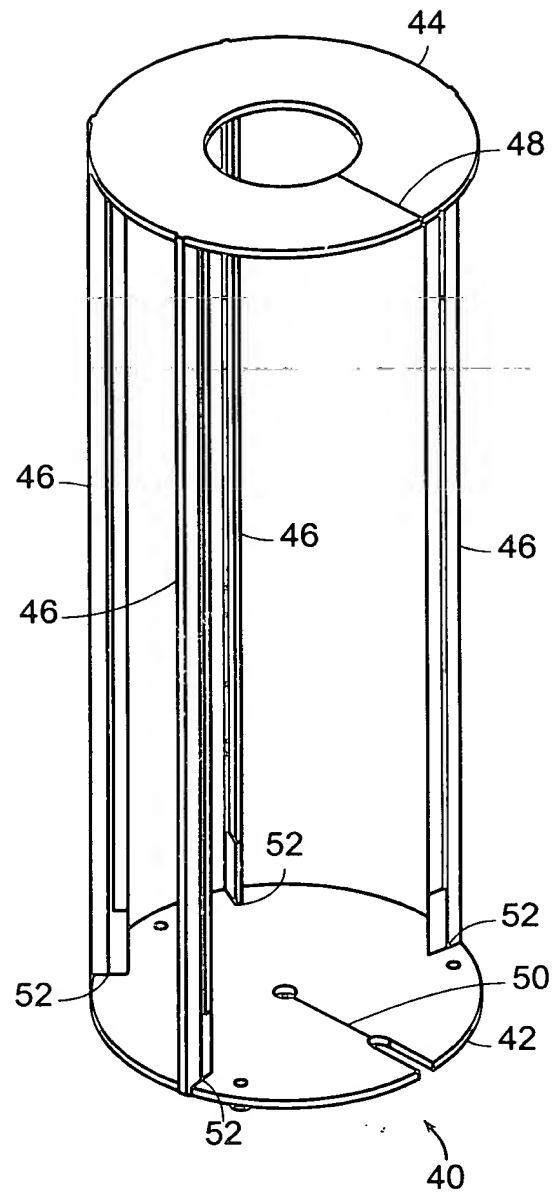


FIG. 4

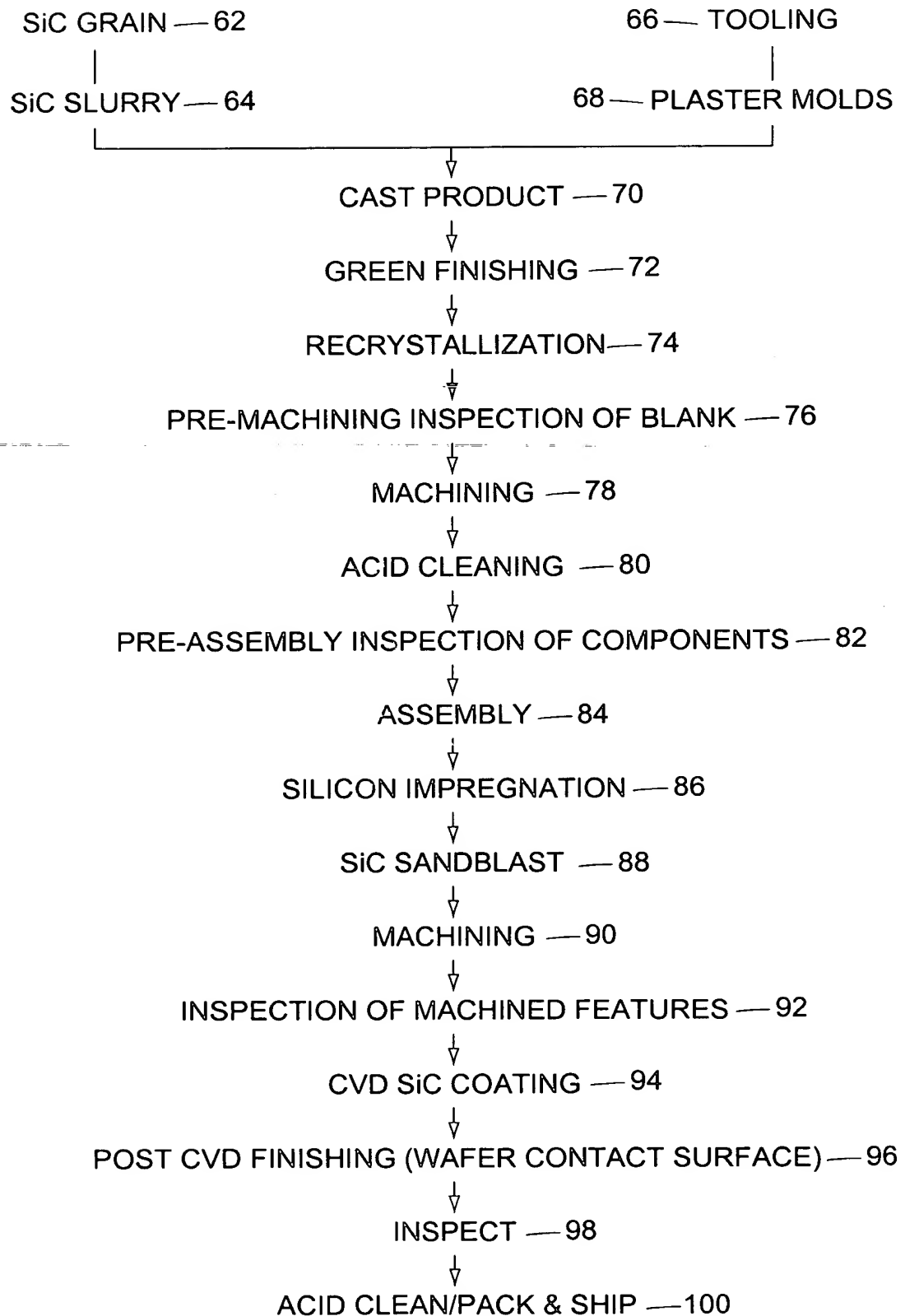


FIG. 5